

Product Change Notification

PCN No.	Quectel_PCN_2018092001	Date of Issue (DD/MM/YYYY)	20/09/2018
1. General Information			
Type of Change	Chipset supplier added a second source for the 32Mbits flash built in MT2503D		
Description of Change	Winbond is added as the second source for the 32Mbits flash built in MT2503D		
Reason of Change	Due to long-term excessive demand of the flash, MTK has decided to add Winbond as the second source.		
2. Information for Affected Products and Alternative Products			
Affected Products Information		Alternative Products Information	
Model	Ordering Code	Model	Ordering Code
MC60	MC60CA-04-STD	MC60	MC60CA-04-STD
MC60	MC60ECA-04-BLE	MC60	MC60ECA-04-BLE
MC60	MC60CA-04-HMX	MC60	MC60CA-04-HMX
MC60	MC60CA-04-SIK	MC60	MC60CA-04-SIK
MC60	MC60CA-04-MPT	MC60	MC60CA-04-MPT
Alternative Products Release Time:			
Samples for Alternative Products will be available from <u>12/11/2018</u> (DD/MM/YYYY).			
Switch Time:			
Alternative Products will be started shipping to customers from <u>12/05/2019</u> (DD/MM/YYYY) if no statement received.			
3. Impacts of the Change			
Risk Assessment	<ol style="list-style-type: none"> MC60CAR01A08/MC60ECAR01A03 and earlier firmware versions are not compatible with Winbond flash. Please use MC60CAR01A09/MC60ECAR01A04 or later versions which are compatible with both GigaDevice and Winbond flash. No hardware design change is involved in customers' devices. Winbond flash has been verified and approved by MTK. 		
Suggested Implementation Plan	It is necessary for customers to test the Alternative Products.		
4. Customer Acknowledgement of Receipt			
Please acknowledge receipt of this change notification by replying to info_PCN@quectel.com .			
If no feedback is received within 30 days after the issue date of this notification, then Quectel may accept that this change has been tacitly accepted and can implement the change as indicated above.			